



EXPEDITED PROCEDURE – EXAMINING GROUP 1725

S/D 10/823,314

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Neo C. Peng et al.	Examiner:	Samuel M Heinrich
Serial No.:	10/823,314	Group Art Unit:	1725
Filed:	April 13, 2004	Docket No.:	303.772US2
Title:	WAFER DICING DEVICE AND METHOD		

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

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This paper responds to the Final Office Action mailed on September 11, 2007. Please amend the above-identified patent application as follows.